



100V N-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

BV _{DSS}	R _{DS(ON)} Max	I _{D MAX} T _C = +25°C
100V	8.5mΩ @ V _{GS} = 10V	50A
	12.5mΩ @ V _{GS} = 4.5V	41A

Description

This MOSFET is designed to minimize the on-state resistance (R_{DS(ON)}) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

Applications

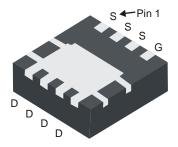
- Synchronous Rectifier
- Backlighting
- **Power Management Functions**
- **DC-DC Converters**

Features and Benefits

- Low R_{DS(ON)} Ensures On State Losses are Minimized
- Excellent Qgd x RDS (ON) Product (FOM)
- Advanced Technology for DC/DC Converters
- Small Form Factor Thermally Efficient Package Enables Higher **Density End Products**
- Occupies Just 33% of the Board Area Occupied by SO-8 Enabling Smaller End Product
- 100% Unclamped Inductive Switching (UIS) Test in Production -Ensures More Reliable and Robust End Application
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

Mechanical Data

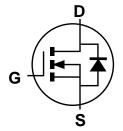
- Case: PowerDI®3333-8
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: See Diagram
- Terminals: Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 @3
- Weight: 0.008 grams (Approximate)



Bottom View



Top View



Equivalent Circuit

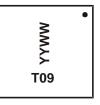
Ordering Information (Note 4)

Part Number	Case	Packaging
DMT10H009LFG-7	PowerDI3333-8	2,000/Tape & Reel
DMT10H009LFG-13	PowerDI3333-8	3,000/Tape & Reel

Notes:

- 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
- 2. See http://www.diodes.com/quality/lead_free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green"
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website athttps://www.diodes.com/design/support/packaging/diodes-packaging/

Marking Information



T09 = Product Type Marking Code YYWW = Date Code Marking YY = Last Two Digits of Year (ex: 19 = 2019) WW = Week Code (01 to 53)



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Drain-Source Voltage		V _{DSS}	100	V	
Gate-Source Voltage		V _{GSS}	±20	V	
	T _A = +25°C	,	13	- A	
Continuous Drain Current (Note 5) V _{GS} = 10V	T _A = +70°C	l _D	11		
	T _C = +25°C	ı	50	A	
	T _C = +70°C	- I _D	40		
Maximum Continuous Body Diode Forward Current (Note 5)	Is	25	Α		
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)	I _{DM}	200	Α		
Pulsed Body Diode Continuous Current (10µs Pulse, Duty Cy	I _{SM}	200	А		
Avalanche Current (L = 1mH)	I _{AS}	17	Α		
Avalanche Energy (L = 1mH)		E _{AS}	144.5	mJ	

Thermal Characteristics (@TA = +25°C, unless otherwise specified.)

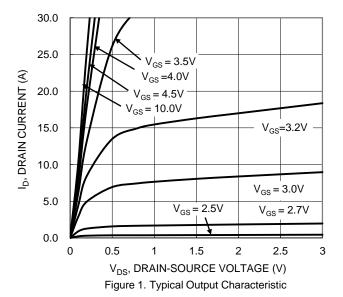
Characteristic	Symbol	Value	Unit	
Total Power Dissipation (Note 5)	P_{D}	2	W	
Thermal Resistance, Junction to Ambient (Note 5)	$R_{ heta JA}$	59	°C/W	
Total Power Dissipation	P_{D}	30	W	
Thermal Resistance, Junction to Case		$R_{ heta JC}$	3.8	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C	

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 6)							
Drain-Source Breakdown Voltage	BV _{DSS}	100	_	_	٧	$V_{GS} = 0V$, $I_D = 1mA$	
Zero Gate Voltage Drain Current	I _{DSS}	_	_	1	μΑ	$V_{DS} = 80V, V_{GS} = 0V$	
Gate-Source Leakage	I _{GSS}	_	_	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 6)							
Gate Threshold Voltage	$V_{GS(TH)}$	1.1	_	2.5	V	$V_{DS} = V_{GS}$, $I_D = 250\mu A$	
Static Drain-Source On-Resistance	D	-	6.4	8.5	mΩ	$V_{GS} = 10V, I_D = 20A$	
Static Drain-Source On-Resistance	R _{DS(ON)}	_	8.2	12.5	11122	$V_{GS} = 4.5V, I_D = 10A$	
Diode Forward Voltage	V_{SD}	_	0.8	1.2	V	$V_{GS} = 0V, I_{S} = 20A$	
DYNAMIC CHARACTERISTICS (Note 7)							
Input Capacitance	C _{iss}		2361	_		$V_{DS} = 50V$, $V_{GS} = 0V$ f = 1MHz	
Output Capacitance	Coss	-	611	_	pF		
Reverse Transfer Capacitance	Crss	_	16	_			
Gate Resistance	R_g	-	1.7	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$	
Total Gate Charge	Qg	_	41	_			
Gate-Source Charge	Qgs	_	7.3	_	nC	$V_{DD} = 50V, I_D = 13A,$ $V_{GS} = 10V$	
Gate-Drain Charge	Q_{gd}	_	9.3	_		VGS = 10V	
Turn-On Delay Time	t _{D(ON)}	_	7	_			
Turn-On Rise Time	t _R	_	12	_	ns	$V_{DD} = 50V, V_{GS} = 10V,$ $I_D = 13A, R_g = 6\Omega$	
Turn-Off Delay Time	t _{D(OFF)}	_	42	_	115		
Turn-Off Fall Time	t _F	_	24	_		_	
Reverse Recovery Time	t _{RR}	_	45	_	ns	I_ 12A di/dt 100A/vo	
Reverse Recovery Charge	Q _{RR}	_	68	_	nC	I _F = 13A, di/dt = 100A/μs	

5. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.6. Short duration pulse test used to minimize self-heating effect.7. Guaranteed by design. Not subject to product testing.





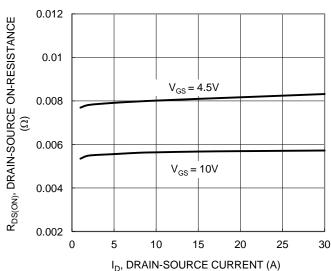


Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage

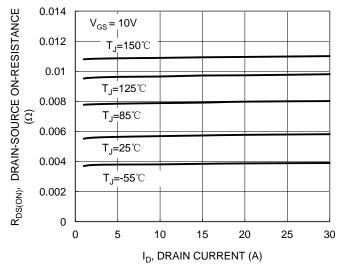
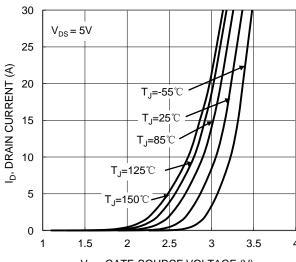


Figure 5. Typical On-Resistance vs. Drain Current and Junction Temperature



V_{GS}, GATE-SOURCE VOLTAGE (V) Figure 2. Typical Transfer Characteristic

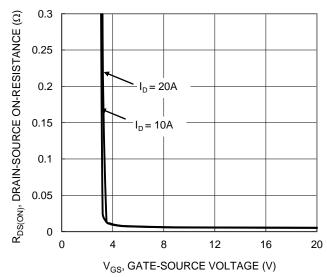
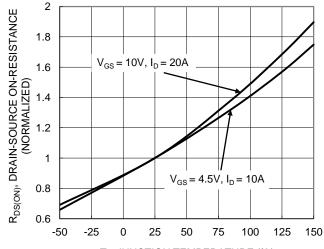


Figure 4. Typical Transfer Characteristic



 $\label{eq:TJ} T_J, JUNCTION TEMPERATURE (°C)$ Figure 6. On-Resistance Variation with Junction Temperature





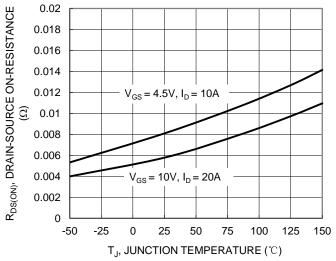


Figure 7. On-Resistance Variation with Junction Temperature

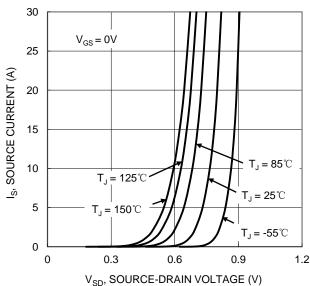


Figure 9. Diode Forward Voltage vs. Current

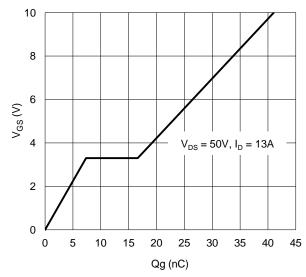


Figure 11. Gate Charge

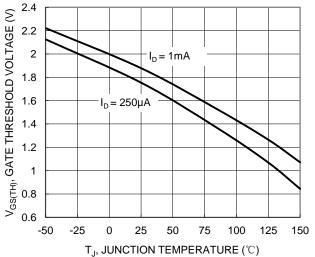
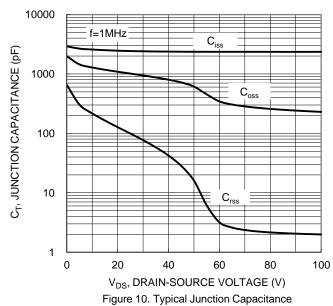


Figure 8. Gate Threshold Variation vs. Junction Temperature



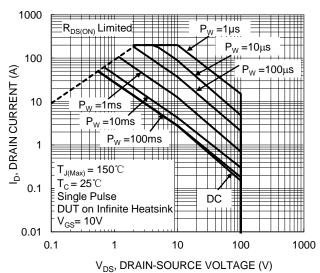


Figure 12. SOA, Safe Operation Area



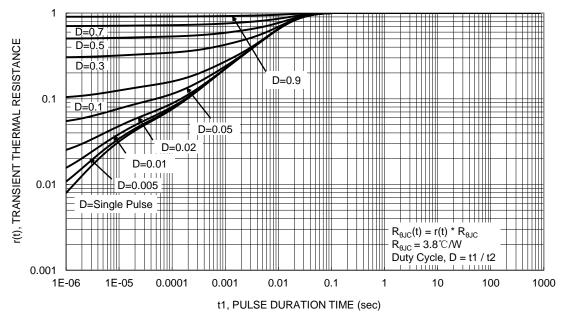


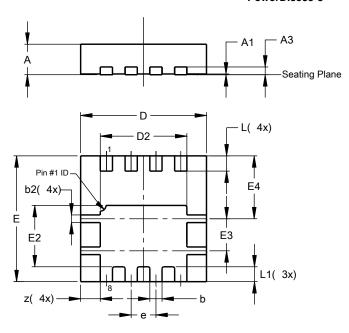
Figure 13. Transient Thermal Resistance



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI3333-8

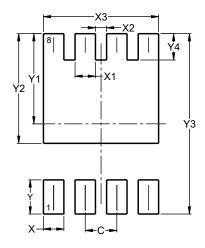


PowerDI3333-8				
Dim	Min	Max	Тур	
Α	0.75	0.85	0.80	
A1	0.00	0.05	0.02	
A3	_	_	0.203	
b	0.27	0.37	0.32	
b2	0.15	0.25	0.20	
D	3.25	3.35	3.30	
D2	2.22	2.32	2.27	
Е	3.25	3.35	3.30	
E2	1.56	1.66	1.61	
E3	0.79	0.89	0.84	
E4	1.60	1.70	1.65	
е	_	_	0.65	
L	0.35	0.45	0.40	
L1	_	_	0.39	
Z	_	_	0.515	
All Dimensions in mm				

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI3333-8



Dimensions	Value (in mm)
С	0.650
X	0.420
X1	0.420
X2	0.230
Х3	2.370
Υ	0.700
Y1	1.850
Y2	2.250
Y3	3.700
Y4	0.540



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